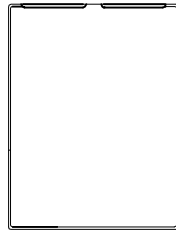


1 2 3 4 5 6 7 8 9

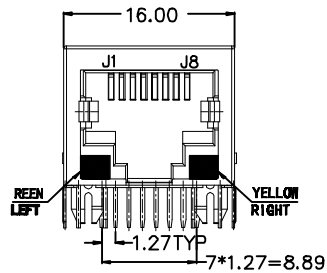
F



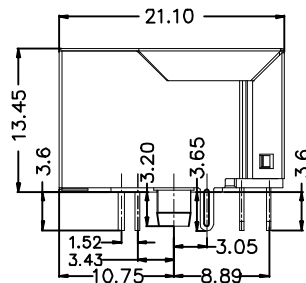
TOP VIEW

**MATERIAL:**  
 HOUSING : PBT,UL94V-0,BLACK.  
 TERMINALS BRACKET: PBT,UL94V-0,BLACK  
 SHIELD: C2680,T=0.20MM  
 TERMINAL: PHOSPHOR BRONZE,T=0.35MM

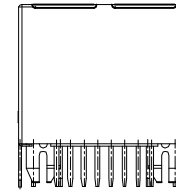
E



FRONT VIEW



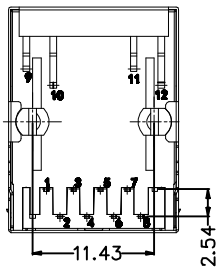
RIGHT SIDE VIEW



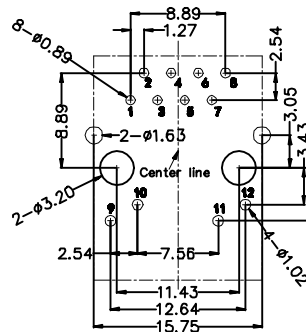
BACK VIEW

D

C



BOTTOM VIEW



RECOMMENDED PCB LAYOUT

B

### Ordering Information

C TEB217 - 08 XX B 009 A X A X  
 No. of pins 08      Standard Plating 53=Gold 6u"/Tin      Color 1=Black      Standard Packing B=Tray

A



REV. A    UNIT. mm    SCALE. 1:1

3RD.ANG PROJ.  
  
 PAGE. 1/3

GENERAL TOLERANCE	
X. 5.0'	X. ? .35
.X 3.0'	.X ? .30
.XX 2.0'	.XX ? .25
.XXX 1.0'	.XXX ? .15

DESIGNED:  
 CHECKED:  
 APPROVED:

DATE:  
 DATE:  
 DATE:

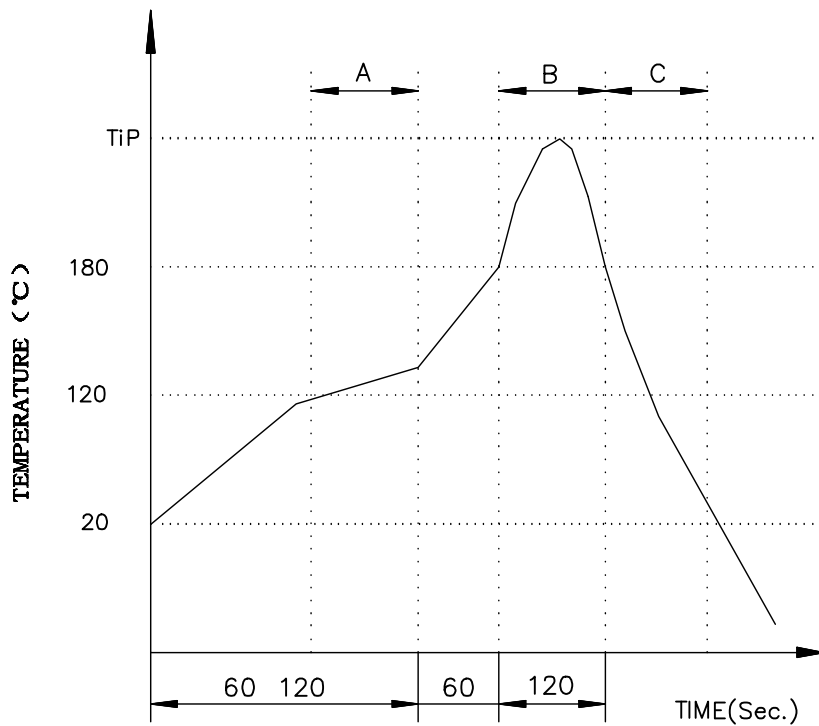
DWG. NO. CTEB217-CB009  
 PART NO. CTEB217-08XXB009AXAX

TITLE. RJ45 TAB-DOWN 1\*1 100BASE

1 2 3 4 5 6 7 8 9



# PROFILE OF WAVE SOLDER



A.Preheating B.Soldering C.Gradual Cooling  
 Tip temperature: 260±5°C.  
 Tip temperature time: 5Sec Max.  
 Tip melting point of Sn96.5/Ag3/Cu0.5: 217°C.

Remarks: after wave soldering, the plastic positioning columns of the product which under the PCB will be slightly melted, but it won't affect its function

<p>Website: www.greenconn.com E-mail: sales@greenconn.com</p>	<p>3RD.ANG PROJ.</p>	<p>GENERAL TOLERANCE</p>		<p>DESIGNED:</p>	<p>DATE:</p>	<p>DWG. NO.</p> <p>CTEB217-CB009</p>	<p>TITLE.</p> <p>RJ45 TAB-DOWN 1*1 100BASE</p>
		<p>X. 5.0'</p> <p>.X 3.0'</p> <p>.XX 2.0'</p> <p>.XXX 1.0'</p>	<p>X.? .35</p> <p>.X? .30</p> <p>.XX? .25</p> <p>.XXX? .15</p>	<p>CHECKED:</p> <p>APPROVED:</p>	<p>DATE:</p> <p>DATE:</p> <p>DATE:</p>	<p>PART NO.</p> <p>CTEB217-08XXB009AXAX</p>	
<p>REV. A</p>	<p>UNIT. mm</p>	<p>SCALE. 1:1</p>	<p>PAGE. 3/3</p>				